# Automotive: CY8C29466 and CY8C29666



#### **Features**

#### ■ Powerful Harvard Architecture Processor

- M8C Processor Speeds to 12 MHz
- ☐ Two 8x8 Multiply, 32-Bit Accumulate
- Low Power at High Speed
- 4.75V to 5.25V Operating Voltage
- ☐ Automotive Temp. Range: -40°C to +125°C

#### Advanced Peripherals (PSoC Blocks)

- □ 12 Rail-to-Rail Analog PSoC Blocks Provide:
  - Up to 14-Bit ADCs
  - Up to 9-Bit DACs
  - Programmable Gain Amplifiers
  - Programmable Filters and Comparators
- ☐ 16 Digital PSoC Blocks Provide:
  - 8- to 32-Bit Timers, Counters, and PWMs
  - CRC and PRS Modules
  - Up to 4 Full-Duplex UARTs
  - Multiple SPI™ Masters or Slaves
  - Connectable to all GPIO Pins
- ☐ Complex Peripherals by Combining Blocks

#### ■ Precision, Programmable Clocking

- ☐ Internal ±4% 24 MHz Oscillator
- □ 24 MHz with Optional 32.768 kHz Crystal
- Optional External Oscillator, up to 24 MHz
- ☐ Internal Oscillator for Watchdog and Sleep

#### **■** Flexible On-Chip Memory

- 32K Bytes Flash Program Storage 100 Erase/Write Cycles
- 2K Bytes SRAM Data Storage
- ☐ In-System Serial Programming (ISSP)
- Partial Flash Updates
- ☐ Flexible Protection Modes

#### ■ Programmable Pin Configurations

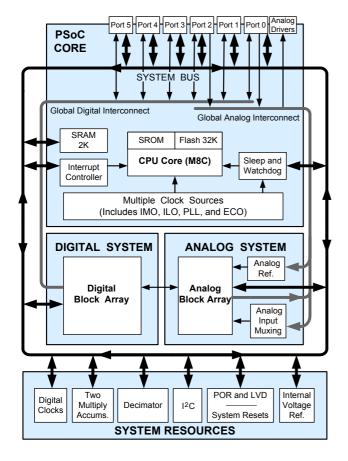
- ☐ 25 mA Sink on All GPIO
- Pull Up, Pull Down, High Z, Strong, or Open Drain Drive Modes on all GPIO
- Up to 12 Analog Inputs on GPIO
- ☐ Four 30 mA Analog Outputs on GPIO
- ☐ Configurable Interrupt on All GPIO

#### ■ Additional System Resources

- $\ \square \ \ I^2C^{\text{\tiny{TM}}}$  Slave, Master, and Multi-Master to 400 kHz
- Watchdog and Sleep Timers
- ☐ User-Configurable Low Voltage Detection
- ☐ Integrated Supervisory Circuit
- On-Chip Precision Voltage Reference

#### ■ Complete Development Tools

- ☐ Free Development Software (PSoC™ Designer)
- ☐ Full-Featured, In-Circuit Emulator and Programmer
- ☐ Full Speed Emulation
- ☐ Complex Breakpoint Structure
- ☐ 128K Bytes Trace Memory
- Complex Events
- C Compilers, Assembler, and Linker



#### **PSoC® Functional Overview**

The PSoC® family consists of many Mixed-Signal Array with On-Chip Controller devices. These devices are designed to replace multiple traditional MCU-based system components with one, low cost single-chip programmable device. PSoC devices include configurable blocks of analog and digital logic, as well as programmable interconnects. This architecture allows the user to create customized peripheral configurations that match the requirements of each individual application. Additionally, a fast CPU, Flash program memory, SRAM data memory, and configurable IO are included in a range of convenient pinouts and packages.

The PSoC architecture, as illustrated on the left, is comprised of four main areas: PSoC Core, Digital System, Analog System, and System Resources. Configurable global busing allows all the device resources to be combined into a complete custom system. The PSoC CY8C29x66 automotive family can have up to six IO ports that connect to the global digital and analog interconnects, providing access to 16 digital blocks and 12 analog blocks.

#### The PSoC Core

The PSoC Core is a powerful engine that supports a rich feature set. The core includes a CPU, memory, clocks, and configurable GPIO (General Purpose IO).

The M8C CPU core is a powerful processor with speeds up to 12 MHz, providing a two MIPS 8-bit Harvard architecture micro-

processor. The CPU utilizes an interrupt controller with 25 vectors, to simplify programming of real time embedded events. Program execution is timed and protected using the included Sleep and Watch Dog Timers (WDT).

Memory includes 32K of Flash for program storage and 2K of SRAM for data storage. Program Flash utilizes four protection levels on blocks of 64 bytes, allowing customized software IP protection.

The PSoC device incorporates flexible internal clock generators, including a 24 MHz IMO (internal main oscillator) accurate to 4% over temperature and voltage. A low power 32 kHz ILO (internal low speed oscillator) is provided for the Sleep timer and WDT. If crystal accuracy is desired, the ECO (32.768 kHz external crystal oscillator) is available for use as a Real Time Clock (RTC) and can optionally generate a crystal-accurate 24 MHz system clock using a PLL. The clocks, together with programmable clock dividers (as a System Resource), provide the flexibility to integrate almost any timing requirement into the PSoC device.

PSoC GPIOs provide connection to the CPU, digital and analog resources of the device. Each pin's drive mode may be selected from eight options, allowing great flexibility in external interfacing. Every pin also has the capability to generate a system interrupt on high level, low level, and change from last read.

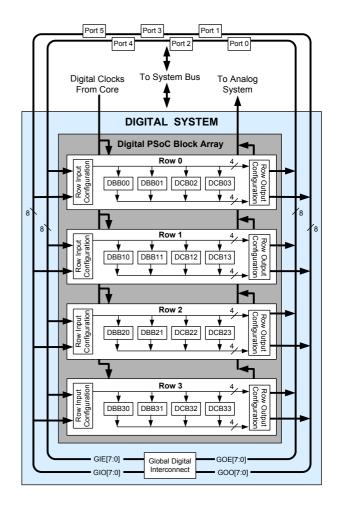
#### The Digital System

The Digital System is composed of 16 digital PSoC blocks. Each block is an 8-bit resource that can be used alone or combined with other blocks to form 8, 16, 24, and 32-bit peripherals, which are called user module references. Digital peripheral configurations include those listed below.

- PWMs (8 to 32 bit)
- PWMs with Dead Band (8 to 32 bit)
- Counters (8 to 32 bit)
- Timers (8 to 32 bit)
- UART 8 bit with selectable parity (up to 4)
- SPI Master and Slave (up to 4 each)
- I2C Slave and Multi-Master (1 available as a System Resource)
- Cyclical Redundancy Checker/Generator (8 to 32 bit)
- IrDA (up to 4)
- Pseudo Random Sequence Generators (8 to 32 bit)

The digital blocks can be connected to any GPIO through a series of global buses that can route any signal to any pin. The buses also allow for signal multiplexing and for performing logic operations. This configurability frees your designs from the constraints of a fixed peripheral controller.

Digital blocks are provided in rows of four, where the number of blocks varies by PSoC device family. This allows you the optimum choice of system resources for your application. Family resources are shown in the table titled "PSoC Device Characteristics" on page 3.



**Digital System Block Diagram** 

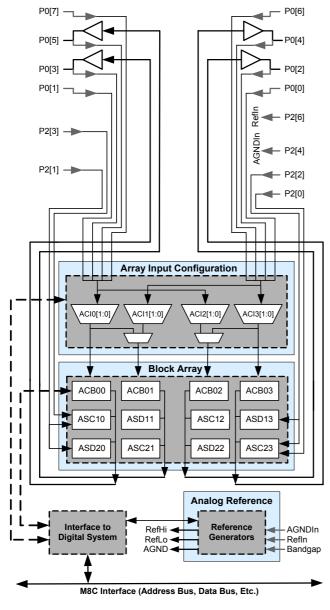
#### The Analog System

The Analog System is composed of 12 configurable blocks, each comprised of an opamp circuit allowing the creation of complex analog signal flows. Analog peripherals are very flexible and can be customized to support specific application requirements. Some of the more common PSoC analog functions (most available as user modules) are listed below.

- Analog-to-digital converters (up to 4, with 6- to 14-bit resolution, selectable as Incremental, Delta Sigma, and SAR)
- Filters (2, 4, 6, or 8 pole band-pass, low-pass, and notch)
- Amplifiers (up to 4, with selectable gain to 48x)
- Instrumentation amplifiers (up to 2, with selectable gain to 93x)
- Comparators (up to 4, with 16 selectable thresholds)
- DACs (up to 4, with 6- to 9-bit resolution)
- Multiplying DACs (up to 4, with 6- to 9-bit resolution)
- High current output drivers (four with 40 mA drive as a PSoC Core resource)
- 1.3V reference (as a System Resource)
- DTMF Dialer

- Modulators
- Correlators
- Peak Detectors
- Many other topologies possible

Analog blocks are provided in columns of three, which includes one CT (Continuous Time) and two SC (Switched Capacitor) blocks, as shown in the figure below.



**Analog System Block Diagram** 

#### **Additional System Resources**

System Resources, some of which have been previously listed, provide additional capability useful to complete systems. Additional resources include a multiplier, decimator, switch mode pump, low voltage detection, and power on reset. Brief statements describing the merits of each system resource are presented below.

- Digital clock dividers provide three customizable clock frequencies for use in applications. The clocks can be routed to both the digital and analog systems. Additional clocks can be generated using digital PSoC blocks as clock dividers.
- Two multiply accumulates (MACs) provide fast 8-bit multiplier with 32-bit accumulate to assist in both general math as well as digital filters.
- The decimator provides a custom hardware filter for digital signal, processing applications including the creation of Delta Sigma ADCs.
- The I2C module provides 100 and 400 kHz communication over two wires. Slave, master, and multi-master modes are all supported.
- Low Voltage Detection (LVD) interrupts can signal the application of falling voltage levels, while the advanced POR (Power On Reset) circuit eliminates the need for a system supervisor.
- An internal 1.3 voltage reference provides an absolute reference for the analog system, including ADCs and DACs.

#### **PSoC Device Characteristics**

Depending on your PSoC device characteristics, the digital and analog systems can have 16, 8, or 4 digital blocks and 12, 6, or 4 analog blocks. The following table lists the resources available for specific PSoC device groups. The PSoC device covered by this data sheet is highlighted below.

#### **PSoC Device Characteristics**

PSoC Part Number	Digital IO	Digital Rows	Digital Blocks	Analog Inputs	Analog Outputs	Analog Columns	Analog Blocks	SRAM Size	Flash Size
CY8C29x66	up to 64	4	16	12	4	4	12	2K	32K
CY8C27x43	up to 44	2	8	12	4	4	12	256 Bytes	16K
CY8C24x94	56	1	4	48	2	2	6	1K	16K
CY8C24x23A	up to 24	1	4	12	2	2	6	256 Bytes	4K
CY8C21x34	up to 28	1	4	28	0	2	4 <sup>a</sup>	512 Bytes	8K
CY8C21x23	16	1	4	8	0	2	4 <sup>a</sup>	256 Bytes	4K
CY8C20x34	up to 28	0	0	28	0	0	3 <sup>b</sup>	512 Bytes	8K

- a. Limited analog functionality.
- b. Two analog blocks and one CapSense.

## **Getting Started**

The quickest path to understanding the PSoC silicon is by reading this data sheet and using the PSoC Designer Integrated Development Environment (IDE). This data sheet is an overview of the PSoC integrated circuit and presents specific pin, register, and electrical specifications. For in-depth information, along with detailed programming information, reference the PSoC Mixed-Signal Array Technical Reference Manual.

For up-to-date Ordering, Packaging, and Electrical Specification information, reference the latest PSoC device data sheets on the web at http://www.cypress.com/psoc.

#### **Development Kits**

Development Kits are available from the following distributors: Digi-Key, Avnet, Arrow, and Future. The Cypress Online Store contains development kits, **C** compilers, and all accessories for PSoC development. Go to the Cypress Online Store web site at <a href="http://www.cypress.com">http://www.cypress.com</a>, click the Online Store shopping cart icon at the bottom of the web page, and click *PSoC (Programmable System-on-Chip)* to view a current list of available items.

#### **Technical Training Modules**

Free PSoC technical training modules are available for users new to PSoC. Training modules cover designing, debugging, advanced analog and CapSense. Go to http://www.cypress.com/techtrain.

#### Consultants

Certified PSoC Consultants offer everything from technical assistance to completed PSoC designs. To contact or become a PSoC Consultant go to <a href="http://www.cypress.com">http://www.cypress.com</a>, click on Design Support located on the left side of the web page, and select CYPros Consultants.

#### **Technical Support**

PSoC application engineers take pride in fast and accurate response. They can be reached with a 4-hour guaranteed response at http://www.cypress.com/support/login.cfm.

#### **Application Notes**

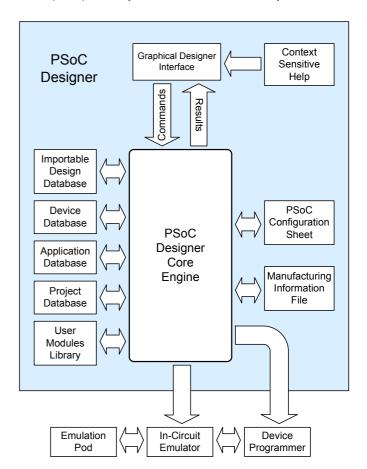
A long list of application notes will assist you in every aspect of your design effort. To view the PSoC application notes, go to the <a href="http://www.cypress.com">http://www.cypress.com</a> web site and select Application Notes under the Design Resources list located in the center of the web page. Application notes are listed by date by default.

### **Development Tools**

PSoC Designer is a Microsoft® Windows-based, integrated development environment for the Programmable System-on-Chip (PSoC) devices. The PSoC Designer IDE and application runs on Windows NT 4.0, Windows 2000, Windows Millennium (Me), or Windows XP. (Reference the PSoC Designer Functional Flow diagram below.)

PSoC Designer helps the customer to select an operating configuration for the PSoC, write application code that uses the PSoC, and debug the application. This system provides design database management by project, an integrated debugger with In-Circuit Emulator, in-system programming support, and the CYASM macro assembler for the CPUs.

PSoC Designer also supports a high-level C language compiler developed specifically for the devices in the family.



**PSoC Designer Subsystems** 

#### **PSoC Designer Software Subsystems**

#### Device Editor

The Device Editor subsystem allows the user to select different onboard analog and digital components called user modules using the PSoC blocks. Examples of user modules are ADCs, DACs, Amplifiers, and Filters.

The device editor also supports easy development of multiple configurations and dynamic reconfiguration. Dynamic configuration allows for changing configurations at run time.

PSoC Designer sets up power-on initialization tables for selected PSoC block configurations and creates source code for an application framework. The framework contains software to operate the selected components and, if the project uses more than one operating configuration, contains routines to switch between different sets of PSoC block configurations at run time. PSoC Designer can print out a configuration sheet for a given project configuration for use during application programming in conjunction with the Device Data Sheet. Once the framework is generated, the user can add application-specific code to flesh out the framework. It's also possible to change the selected components and regenerate the framework.

#### Design Browser

The Design Browser allows users to select and import preconfigured designs into the user's project. Users can easily browse a catalog of preconfigured designs to facilitate time-to-design. Examples provided in the tools include a 300-baud modem, LIN Bus master and slave, fan controller, and magnetic card reader.

#### Application Editor

In the Application Editor you can edit your C language and Assembly language source code. You can also assemble, compile, link, and build.

**Assembler.** The macro assembler allows the assembly code to be merged seamlessly with C code. The link libraries automatically use absolute addressing or can be compiled in relative mode, and linked with other software modules to get absolute addressing.

**C Language Compiler.** A C language compiler is available that supports Cypress MicroSystems' PSoC family devices. Even if you have never worked in the C language before, the product quickly allows you to create complete C programs for the PSoC family devices.

The embedded, optimizing C compiler provides all the features of C tailored to the PSoC architecture. It comes complete with embedded libraries providing port and bus operations, standard keypad and display support, and extended math functionality.

#### Debugger

The PSoC Designer Debugger subsystem provides hardware in-circuit emulation, allowing the designer to test the program in a physical system while providing an internal view of the PSoC device. Debugger commands allow the designer to read and program and read and write data memory, read and write IO registers, read and write CPU registers, set and clear breakpoints, and provide program run, halt, and step control. The debugger also allows the designer to create a trace buffer of registers and memory locations of interest.

#### Online Help System

The online help system displays online, context-sensitive help for the user. Designed for procedural and quick reference, each functional subsystem has its own context-sensitive help. This system also provides tutorials and links to FAQs and an Online Support Forum to aid the designer in getting started.

#### Hardware Tools

#### In-Circuit Emulator

A low cost, high functionality ICE (In-Circuit Emulator) is available for development support. This hardware has the capability to program single devices.

The emulator consists of a base unit that connects to the PC by way of the USB port. The base unit is universal and will operate with all PSoC devices. Emulation pods for each device family are available separately. The emulation pod takes the place of the PSoC device in the target board and performs full speed (24 MHz) operation.

## **Designing with User Modules**

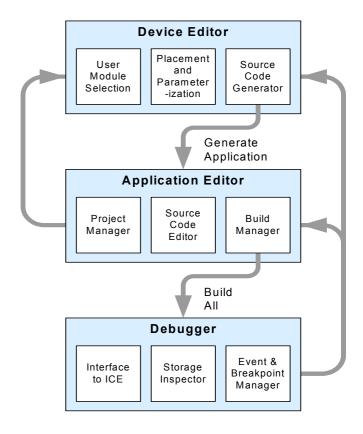
The development process for the PSoC device differs from that of a traditional fixed function microprocessor. The configurable analog and digital hardware blocks give the PSoC architecture a unique flexibility that pays dividends in managing specification change during development and by lowering inventory costs. These configurable resources, called PSoC Blocks, have the ability to implement a wide variety of user-selectable functions. Each block has several registers that determine its function and connectivity to other blocks, multiplexers, buses, and to the IO pins. Iterative development cycles permit you to adapt the hardware as well as the software. This substantially lowers the risk of having to select a different part to meet the final design requirements.

To speed the development process, the PSoC Designer Integrated Development Environment (IDE) provides a library of pre-built, pre-tested hardware peripheral functions, called "User Modules." User modules make selecting and implementing peripheral devices simple, and come in analog, digital, and mixed signal varieties. The standard User Module library contains over 50 common peripherals such as ADCs, DACs Timers, Counters, UARTs, and other not-so common peripherals such as DTMF Generators and Bi-Quad analog filter sections.

Each user module establishes the basic register settings that implement the selected function. It also provides parameters that allow you to tailor its precise configuration to your particular application. For example, a Pulse Width Modulator User Module configures one or more digital PSoC blocks, one for each 8 bits of resolution. The user module parameters permit you to establish the pulse width and duty cycle. User modules also provide tested software to cut your development time. The user module application programming interface (API) provides highlevel functions to control and respond to hardware events at run-time. The API also provides optional interrupt service routines that you can adapt as needed.

The API functions are documented in user module data sheets that are viewed directly in the PSoC Designer IDE. These data sheets explain the internal operation of the user module and provide performance specifications. Each data sheet describes the use of each user module parameter and documents the setting of each register controlled by the user module.

The development process starts when you open a new project and bring up the Device Editor, a graphical user interface (GUI) for configuring the hardware. You pick the user modules you need for your project and map them onto the PSoC blocks with point-and-click simplicity. Next, you build signal chains by interconnecting user modules to each other and the IO pins. At this stage, you also configure the clock source connections and enter parameter values directly or by selecting values from drop-down menus. When you are ready to test the hardware configuration or move on to developing code for the project, you perform the "Generate Application" step. This causes PSoC Designer to generate source code that automatically configures the device to your specification and provides the high-level user module API functions.



**User Module and Source Code Development Flows** 

The next step is to write your main program, and any sub-routines using PSoC Designer's Application Editor subsystem. The Application Editor includes a Project Manager that allows you to open the project source code files (including all generated code files) from a hierarchal view. The source code editor provides syntax coloring and advanced edit features for both C and assembly language. File search capabilities include simple string searches and recursive "grep-style" patterns. A single mouse click invokes the Build Manager. It employs a professional-strength "makefile" system to automatically analyze all file dependencies and run the compiler and assembler as necessary. Project-level options control optimization strategies used by the compiler and linker. Syntax errors are displayed in a console window. Double clicking the error message takes you directly to the offending line of source code. When all is correct, the linker builds a HEX file image suitable for programming.

The last step in the development process takes place inside the PSoC Designer's Debugger subsystem. The Debugger downloads the HEX file to the In-Circuit Emulator (ICE) where it runs at full speed. Debugger capabilities rival those of systems costing many times more. In addition to traditional single-step, runto-breakpoint and watch-variable features, the Debugger provides a large trace buffer and allows you define complex breakpoint events that include monitoring address and data bus values, memory locations and external signals.

#### **Document Conventions**

#### Acronyms Used

The following table lists the acronyms that are used in this document.

Acronym	Description
AC	alternating current
ADC	analog-to-digital converter
API	application programming interface
CPU	central processing unit
CT	continuous time
DAC	digital-to-analog converter
DC	direct current
ECO	external crystal oscillator
EEPROM	electrically erasable programmable read-only memory
FSR	full scale range
GPIO	general purpose IO
GUI	graphical user interface
HBM	human body model
ICE	in-circuit emulator
ILO	internal low speed oscillator
IMO	internal main oscillator
Ю	input/output
IPOR	imprecise power on reset
LSb	least-significant bit
LVD	low voltage detect
MSb	most-significant bit
PC	program counter
PLL	phase-locked loop
POR	power on reset
PPOR	precision power on reset
PSoC®	Programmable System-on-Chip™
PWM	pulse width modulator
SC	switched capacitor
SRAM	static random access memory

### Units of Measure

A units of measure table is located in the Electrical Specifications section. Table 3-1 on page 13 lists all the abbreviations used to measure the PSoC devices.

### **Numeric Naming**

Hexidecimal numbers are represented with all letters in uppercase with an appended lowercase 'h' (for example, '14h' or '3Ah'). Hexidecimal numbers may also be represented by a '0x' prefix, the C coding convention. Binary numbers have an appended lowercase 'b' (e.g., 01010100b' or '01000011b'). Numbers not indicated by an 'h', 'b', or 0x are decimal.

#### **Table of Contents**

For an in depth discussion and more information on your PSoC device, obtain the *PSoC Mixed-Signal Array Technical Reference Manual*. This document encompasses and is organized into the following chapters and sections.

1.	Pin	Information	8
	1.1	Pinouts	
		1.1.1 28-Pin Part Pinout	
		1.1.2 48-Pin Part Pinouts	
2.	Reg	ister Reference	10
	2.1	Register Conventions	
		2.1.1 Abbreviations Used	
	2.2	Register Mapping Tables	10
3.	Elec	trical Specifications	13
	3.1	Absolute Maximum Ratings	14
	3.2	Operating Temperature	
	3.3	DC Electrical Characteristics	
		3.3.1 DC Chip-Level Specifications	
		3.3.2 DC General Purpose IO Specifications	
		3.3.3 DC Operational Amplifier Specifications	
		3.3.4 DC Low Power Comparator Specifications	
		3.3.5 DC Analog Output Buffer Specifications	
		3.3.6 DC Analog Reference Specifications	
		<ul><li>3.3.7 DC Analog PSoC Block Specifications</li><li>3.3.8 DC POR, and LVD Specifications</li></ul>	
		3.3.9 DC Programming Specifications	
	3.4	AC Electrical Characteristics	
	0.4	3.4.1 AC Chip-Level Specifications	
		3.4.2 AC General Purpose IO Specifications	
		3.4.3 AC Operational Amplifier Specifications	
		3.4.4 AC Low Power Comparator Specifications	
		3.4.5 AC Digital Block Specifications	
		3.4.6 AC Analog Output Buffer Specifications	
		3.4.7 AC External Clock Specifications	27
		3.4.8 AC Programming Specifications	
		3.4.9 AC I2C Specifications	28
4.	Pac	kaging Information	29
	4.1	Packaging Dimensions	
	4.2	Thermal Impedances	
	4.3	Capacitance on Crystal Pins	30
	4.4	Solder Reflow Peak Temperature	31
5.	Ord	ering Information	32
	5.1	Ordering Code Definitions	32
6.	Sale	es and Service Information	33
-	6.1	Revision History	
	6.2	Copyrights and Flash Code Protection	

# Pin Information



This chapter describes, lists, and illustrates the CY8C29x66 automotive PSoC device pins and pinout configurations.

#### 1.1 **Pinouts**

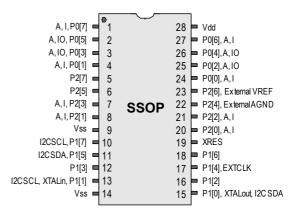
The CY8C29x66 automotive PSoC device is available in a variety of packages which are listed and illustrated in the following tables. Every port pin (labeled with a "P") is capable of Digital IO. However, Vss, Vdd, and XRES are not capable of Digital IO.

#### 1.1.1 28-Pin Part Pinout

Table 1-1: 28-Pin Part Pinout (SSOP)

Pin	Ту	pe	Pin	Description					
No.	Digital	Analog	Name	Description					
1	Ю	ı	P0[7]	Analog column mux input.					
2	Ю	10	P0[5]	Analog column mux input and column output.					
3	Ю	10	P0[3]	Analog column mux input and column output.					
4	Ю	ı	P0[1]	Analog column mux input.					
5	Ю		P2[7]						
6	Ю		P2[5]						
7	Ю	ı	P2[3]	Direct switched capacitor block input.					
8	Ю	ı	P2[1]	Direct switched capacitor block input.					
9	Pov	wer	Vss	Ground connection.					
10	Ю		P1[7]	I2C Serial Clock (SCL).					
11	Ю		P1[5]	I2C Serial Data (SDA).					
12	Ю		P1[3]						
13	Ю		P1[1]	Crystal (XTALin), I2C Serial Clock (SCL), ISSP-SCLK*.					
14	Pov	wer	Vss	Ground connection.					
15	Ю		P1[0]	Crystal (XTALout), I2C Serial Data (SDA), ISSP-SDATA*.					
16	Ю		P1[2]						
17	Ю		P1[4]	Optional External Clock Input (EXTCLK).					
18	Ю		P1[6]						
19	Inp	out	XRES	Active high external reset with internal pull down.					
20	Ю	ı	P2[0]	Direct switched capacitor block input.					
21	Ю	ı	P2[2]	Direct switched capacitor block input.					
22	Ю		P2[4]	External Analog Ground (AGND).					
23	Ю		P2[6]	External Voltage Reference (VREF).					
24	Ю	ı	P0[0]	Analog column mux input.					
25	Ю	10	P0[2]	Analog column mux input and column output.					
26	Ю	10	P0[4]	Analog column mux input and column output.					
27	Ю	ı	P0[6]	Analog column mux input.					
28	Pov	Power Vdd		Supply voltage.					

#### CY8C29466 28-Pin PSoC Device



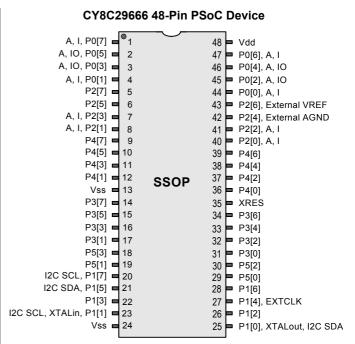
**LEGEND**: A = Analog, I = Input, and O = Output.

\* These are the ISSP pins, which are not High Z at POR (Power On Reset). See the *PSoC Mixed-Signal Array Technical Reference Manual* for details.

#### 1.1.2 48-Pin Part Pinouts

Table 1-2: 48-Pin Part Pinout (SSOP)

Pin	Τv	/pe	Pin				
No.	Digital	Analog	Name	Description			
1	IO		P0[7]	Analog column mux input.			
2	10	10	P0[5]	Analog column mux input and column output.			
3	10	10	P0[3]	Analog column mux input and column output.			
4	10	ı	P0[1]	Analog column mux input.			
5	10	'	P2[7]	7 thatog column max input.			
6	IO		P2[5]				
7	10	1	P2[3]	Direct switched capacitor block input.			
8	10	i	P2[1]	Direct switched capacitor block input.			
9	IO	'	P4[7]	Direct switched capacitor block input.			
10	IO		P4[5]				
11	10		P4[3]				
12	10		P4[1]				
13		wer	Vss	Ground connection.			
14	IO	wei		Ground connection.			
			P3[7]				
15	10		P3[5]				
16	10		P3[3]				
17	10		P3[1]				
18	10		P5[3]				
19	10		P5[1]				
20	10		P1[7]	I2C Serial Clock (SCL).			
21	10		P1[5]	I2C Serial Data (SDA).			
22	10		P1[3]				
23	Ю		P1[1]	Crystal (XTALin), I2C Serial Clock (SCL), ISSP-SCLK*.			
24	Po	wer	Vss	Ground connection.			
25	Ю		P1[0]	Crystal (XTALout), I2C Serial Data (SDA), ISSP-SDATA*.			
26	10		P1[2]				
27	10		P1[4]	Optional External Clock Input (EXTCLK).			
28	10		P1[6]				
29	IO		P5[0]				
30	10		P5[2]				
31	10		P3[0]				
32	IO		P3[2]				
33	10		P3[4]				
34	10		P3[6]				
35		put	XRES	Active high external reset with internal pull down.			
36	IO		P4[0]				
37	10		P4[2]				
38	10		P4[4]				
39	10		P4[6]				
40	IO	1	P2[0]	Direct switched capacitor block input.			
41	10	·	P2[2]	Direct switched capacitor block input.			
42	IO	<u>'</u>	P2[4]	External Analog Ground (AGND).			
43	IO		P2[6]	External Voltage Reference (VREF).			
44	10	ı		Analog column mux input.			
			P0[0]	i i			
45	10	10	P0[2] P0[4]	Analog column mux input and column output.			
46	10	10		Analog column mux input and column output.			
47	10		P0[6]	Analog column mux input.			
48	l Po	wer	Vdd	Supply voltage.			



**LEGEND**: A = Analog, I = Input, and O = Output.

\* These are the ISSP pins, which are not High Z at POR (Power On Reset). See the *PSoC Mixed-Signal Array Technical Reference Manual* for details.

# 2. Register Reference



This chapter lists the registers of the CY8C29x66 automotive PSoC device. For detailed register information, reference the PSoC Mixed-Signal Array Technical Reference Manual.

## 2.1 Register Conventions

#### 2.1.1 Abbreviations Used

The register conventions specific to this section are listed in the following table.

Convention	Description							
R	Read register or bit(s)							
W Write register or bit(s)								
L	Logical register or bit(s)							
С	Clearable register or bit(s)							
#	Access is bit specific							

## 2.2 Register Mapping Tables

The PSoC device has a total register address space of 512 bytes. The register space is referred to as IO space and is divided into two banks. The XOI bit in the Flag register (CPU\_F) determines which bank the user is currently in. When the XOI bit is set the user is in Bank 1.

**Note** In the following register mapping tables, blank fields are Reserved and should not be accessed.

# Register Map Bank 0 Table: User Space

PRT0IE 0 PRT0GS 0 PRT0DM2 0 PRT1DR 0 PRT1IE 0 PRT1IE 0 PRT1IE 0 PRT1IE 0 PRT1DM2 0 PRT2DR 0 PRT2DR 0 PRT2DR 0 PRT2BR 0 PRT3DR 0 PRT3DR 1 PRT3DR 1 PRT3GS 1 PRT4DR 1 PRT4GS 1 PRT4GS 1 PRT4GS 1 PRT5DR 1	000 01 02 03 04 05 06 07 08 09 00A 00B 00C 00D 00E 00F 110 112 13 14 115	RW R	DBB20DR0  DBB20DR1  DBB20DR2  DBB20CR0  DBB21DR0  DBB21DR1  DBB21DR2  DBB21CR0  DCB22DR1  DCB22DR1  DCB22DR2  DCB22CR0  DCB23DR0  DCB23DR1  DCB23DR1  DCB23DR1  DCB23DR2  DCB23DR2	40 41 42 43 44 45 46 47 48 49 4A 4B 4C	# W RW # # W RW # # W RW # # # W RW # # # #	ASC10CR0 ASC10CR1 ASC10CR2 ASC10CR3 ASD11CR0 ASD11CR1 ASD11CR2 ASD11CR3 ASC12CR0 ASC12CR1 ASC12CR2 ASC12CR2	80 81 82 83 84 85 86 87 88 89	RW RW RW RW RW RW RW RW RW	RDI2RI RDI2SYN RDI2IS RDI2LTO RDI2LT1 RDI2RO0 RDI2RO1 RDI3RI RDI3SYN	C0 C1 C2 C3 C4 C5 C6 C7 C8	RW RW RW RW RW RW RW
PRTOGS 0 PRTODM2 0 PRT1DR 0 PRT1IE 0 PRT1IE 0 PRT1GS 0 PRT1DM2 0 PRT1DM2 0 PRT2DR 0 PRT2DR 0 PRT2E 0 PRT2E 0 PRT3DR 0 PRT3DM2 0 PRT3DM2 1 PRT4DM2 1 PRT4DM2 1 PRT4DM2 1 PRT4DM2 1 PRT5DR 1 PRT4GS 1 PRT5DR 1 PRT5DM2 1	02 03 04 05 06 07 08 09 0A 0B 0C 0D 0D 0D 11 11 12 13 14	RW RW RW RW RW RW RW RW RW RW RW RW RW R	DBB20DR2 DBB20CR0 DBB21DR0 DBB21DR1 DBB21DR2 DBB21CR0 DCB22DR0 DCB22DR1 DCB22DR2 DCB22DR2 DCB22DR2 DCB23DR0 DCB23DR0 DCB23DR1 DCB23DR1	42 43 44 45 46 47 48 49 4A 4B 4C 4D	RW # # W RW # # W RW # # W RW #	ASC10CR2 ASC10CR3 ASD11CR0 ASD11CR1 ASD11CR2 ASD11CR3 ASC12CR0 ASC12CR1 ASC12CR2	82 83 84 85 86 87 88 89	RW RW RW RW RW RW RW	RDI2IS RDI2LT0 RDI2LT1 RDI2RO0 RDI2RO1 RDI3RI	C2 C3 C4 C5 C6 C7 C8	RW RW RW RW RW
PRT0DM2 0 PRT1DR 0 PRT1IE 0 PRT1IE 0 PRT1GS 0 PRT1DM2 0 PRT2DR 0 PRT2DR 0 PRT2DR 0 PRT2BE 0 PRT3BE 0 PRT3BE 0 PRT3BE 1 PRT4DR 1 PRT4BE 1 PRT4GS 1 PRT4DR 1 PRT5DR 1 PRT5DM2 1	03 04 05 06 07 08 09 0A 0B 0C 0D 0D 11 11 11 11 113 114	RW RW RW RW RW RW RW RW RW RW RW RW RW R	DBB20CR0 DBB21DR0 DBB21DR1 DBB21DR2 DBB21CR0 DCB22DR0 DCB22DR1 DCB22DR2 DCB22DR2 DCB22DR2 DCB23DR0 DCB23DR1 DCB23DR1 DCB23DR1 DCB23DR1	43 44 45 46 47 48 49 4A 4B 4C 4D	# W RW # # W RW	ASC10CR3 ASD11CR0 ASD11CR1 ASD11CR2 ASD11CR3 ASC12CR0 ASC12CR1 ASC12CR2	83 84 85 86 87 88 89	RW RW RW RW RW RW	RDI2LT0 RDI2LT1 RDI2RO0 RDI2RO1 RDI3RI	C3 C4 C5 C6 C7 C8	RW RW RW RW
PRT1DR 0 PRT1IE 0 PRT1IE 0 PRT1GS 0 PRT1GS 0 PRT1DM2 0 PRT2DR 0 PRT2DR 0 PRT2E 0 PRT2BS 0 PRT2DM2 0 PRT3DM2 0 PRT3IE 0 PRT3GS 1 PRT4DR 1 PRT4GS 1 PRT4GS 1 PRT5DR 1	04 05 06 07 08 09 0A 0B 0C 0D 0D 0D 11 11 12 13 14	RW RW RW RW RW RW RW RW RW RW RW RW RW	DBB21DR0 DBB21DR1 DBB21DR2 DBB21CR0 DCB22DR0 DCB22DR1 DCB22DR2 DCB22CR0 DCB23DR0 DCB23DR1 DCB23DR1 DCB23DR2	44 45 46 47 48 49 4A 4B 4C 4D	# W RW # # W RW	ASD11CR0 ASD11CR1 ASD11CR2 ASD11CR3 ASC12CR0 ASC12CR1 ASC12CR2	84 85 86 87 88 89	RW RW RW RW RW	RDI2LT1 RDI2RO0 RDI2RO1 RDI3RI	C4 C5 C6 C7 C8	RW RW RW
PRT1IE 0 PRT1GS 0 PRT1GS 0 PRT1DM2 0 PRT2DR 0 PRT2DR 0 PRT2E 0 PRT2GS 0 PRT3DM2 0 PRT3DR 0 PRT3BC 0 PRT3BC 1 PRT4GS 1 PRT4GS 1 PRT4GS 1 PRT5DR 1 PR	05 06 07 08 09 0A 0B 0C 0D 0E 0F 11 11 12 13 14	RW RW RW RW RW RW RW RW RW RW RW	DBB21DR1 DBB21DR2 DBB21CR0 DCB22DR0 DCB22DR1 DCB22DR2 DCB22CR0 DCB23DR0 DCB23DR1 DCB23DR1 DCB23DR2	45 46 47 48 49 4A 4B 4C 4D	W RW # # W RW	ASD11CR1 ASD11CR2 ASD11CR3 ASC12CR0 ASC12CR1 ASC12CR2	85 86 87 88 89	RW RW RW RW	RDI2RO0 RDI2RO1 RDI3RI	C5 C6 C7 C8	RW RW RW
PRT1GS 0 PRT1DM2 0 PRT2DR 0 PRT2DR 0 PRT2IE 0 PRT2GS 0 PRT2DM2 0 PRT3DR 0 PRT3DR 0 PRT3IE 1 PRT3GS 1 PRT4DR 1 PRT4IE 1 PRT4GS 1 PRT5DR 1 P	06 07 08 09 0A 0B 0C 0D 0E 0F 10 11 11 12	RW RW RW RW RW RW RW RW RW RW	DBB21DR2 DBB21CR0 DCB22DR0 DCB22DR1 DCB22DR2 DCB22CR0 DCB23DR0 DCB23DR1 DCB23DR1 DCB23DR2 DCB23CR0	46 47 48 49 4A 4B 4C 4D	RW # # W RW #	ASD11CR2 ASD11CR3 ASC12CR0 ASC12CR1 ASC12CR2	86 87 88 89	RW RW RW	RDI2RO1 RDI3RI	C6 C7 C8	RW
PRT1DM2 0 PRT2DR 0 PRT2DR 0 PRT2IE 0 PRT2GS 0 PRT2DM2 0 PRT3DR 0 PRT3DR 0 PRT3IE 0 PRT3GS 0 PRT3DM2 1 PRT4DR 1 PRT4DR 1 PRT4DR 1 PRT4DR 1 PRT5DR 1 PRT5DR 1 PRT5DR 1 PRT5DR 1 PRT5DR 1 PRT5DM2 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	07 08 09 0A 0B 0C 0D 0E 0F 10 11 12 13 14	RW RW RW RW RW RW RW RW RW	DBB21CR0 DCB22DR0 DCB22DR1 DCB22DR2 DCB22CR0 DCB23DR0 DCB23DR1 DCB23DR1 DCB23DR2 DCB23CR0	47 48 49 4A 4B 4C 4D	# # W RW #	ASD11CR3 ASC12CR0 ASC12CR1 ASC12CR2	87 88 89	RW RW RW	RDI3RI	C7 C8	RW
PRT2DR 0 PRT2IE 0 PRT2IE 0 PRT2GS 0 PRT2DM2 0 PRT3DR 0 PRT3DR 0 PRT3GS 0 PRT3M2 1 PRT4DR 1 PRT4DR 1 PRT4GS 1 PRT4DR 1 PRT5DR 1 PR	08	RW RW RW RW RW RW RW RW	DCB22DR0 DCB22DR1 DCB22DR2 DCB22CR0 DCB23DR0 DCB23DR1 DCB23DR1 DCB23DR2 DCB23CR0	48 49 4A 4B 4C 4D	# W RW #	ASC12CR0 ASC12CR1 ASC12CR2	88 89	RW RW		C8	
PRT2IE 0 PRT2GS 0 PRT2DM2 0 PRT3DR 0 PRT3DR 0 PRT3IE 0 PRT3GS 0 PRT3DM2 1 PRT4DR 1 PRT4DR 1 PRT4IE 1 PRT4GS 1 PRT5DR 1 PRT5DR 1 PRT5DR 1 PRT5DR 1 PRT5DR 1 PRT5DM2 1 1 DBB00DR0 2 DBB00DR0 2	09 0A 0B 0B 0C 0D 0E 0F 110 111 112 113 114	RW RW RW RW RW RW RW	DCB22DR1 DCB22DR2 DCB22CR0 DCB23DR0 DCB23DR1 DCB23DR2 DCB23CR0	49 4A 4B 4C 4D	W RW #	ASC12CR1 ASC12CR2	89	RW			
PRT2GS 0 PRT2DM2 0 PRT3DR 0 PRT3DR 0 PRT3IE 0 PRT3GS 0 PRT3DM2 0 PRT4DR 1 PRT4HE 1 PRT4GS 1 PRT5DR 1 PRT5DR 1 PRT5DR 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	DA DB DB DC DD DE DF 110 111 112 113 114 115	RW RW RW RW RW RW	DCB22DR2 DCB22CR0 DCB23DR0 DCB23DR1 DCB23DR2 DCB23CR0	4A 4B 4C 4D	RW #	ASC12CR2			RDI3SYN	C9	RW
PRT2DM2 0 PRT3DR 0 PRT3DR 0 PRT3IE 0 PRT3GS 0 PRT3DM2 0 PRT4DR 1 PRT4IE 1 PRT4GS 1 PRT5DR 1 PRT5DR 1 PRT5DR 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	0B 0C 0D 0E 0E 0F 110 111 112 113 114	RW RW RW RW RW	DCB22CR0 DCB23DR0 DCB23DR1 DCB23DR2 DCB23CR0	4B 4C 4D	#		8A				
PRT3DR 0 PRT3IE 0 PRT3IE 0 PRT3GS 0 PRT3DM2 0 PRT4DR 1 PRT4IE 1 PRT4GS 1 PRT5DR 1 PRT5IE 1 PRT5DR 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	0C 0D 0E 0F 110 111 12 13 14	RW RW RW RW	DCB23DR0 DCB23DR1 DCB23DR2 DCB23CR0	4C 4D		ASC12CR3		RW	RDI3IS	CA	RW
PRT3IE 0 PRT3GS 0 PRT3DM2 0 PRT4DR 1 PRT4IE 1 PRT4GS 1 PRT5DR 1 PRT5DR 1 PRT5DR 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	DD DE DE DF 110 111 112 113 114 115	RW RW RW	DCB23DR1 DCB23DR2 DCB23CR0	4D	#		8B	RW	RDI3LT0	CB	RW
PRT3GS 0 PRT3DM2 0 PRT4DR 1 PRT4IE 1 PRT4GS 1 PRT5DR 1 PRT5DR 1 PRT5GS 1 PRT5DM2 1 1 1 1 1 1 1 DBB00DR0 2 DBB00DR1 2	0E 0F 10 11 12 13 14	RW RW RW	DCB23DR2 DCB23CR0			ASD13CR0	8C	RW	RDI3LT1	CC	RW
PRT3DM2 0 PRT4DR 1 PRT4IE 1 PRT4GS 1 PRT4DM2 1 PRT5DR 1 PRT5DR 1 PRT5GS 1 PRT5DM2 1 1 1 1 1 1 1 DBB00DR0 2 DBB00DR1 2	0F 10 11 12 13 14	RW RW	DCB23CR0	1 E	W	ASD13CR1	8D	RW	RDI3RO0	CD	RW
PRT4DR 1 PRT4IE 1 PRT4GS 1 PRT4GS 1 PRT5DR 1 PRT5DR 1 PRT5GS 1 PRT5DM2 1 1 1 1 1 1 1 DBB00DR0 2 DBB00DR1 2	10 11 12 13 14	RW		4E	RW	ASD13CR2	8E	RW	RDI3RO1	CE	RW
PRT4IE 1 PRT4GS 1 PRT4DM2 1 PRT5DR 1 PRT5IE 1 PRT5GS 1 PRT5DM2 1 1 1 1 1 1 1 DBB00DR0 2 DBB00DR1 2	11 12 13 14			4F	#	ASD13CR3	8F	RW		CF	
PRT4GS 1 PRT4DM2 1 PRT5DR 1 PRT5DR 1 PRT5IE 1 PRT5GS 1 PRT5DM2 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	12 13 14 15	RW	DBB30DR0	50	#	ASD20CR0	90	RW	CUR_PP	D0	RW
PRT4DM2 1 PRT5DR 1 PRT5IE 1 PRT5GS 1 PRT5DM2 1 1 1 1 1 1 1 DBB00DR0 2 DBB00DR1 2	13 14 15		DBB30DR1	51	W	ASD20CR1	91	RW	STK_PP	D1	RW
PRT5DR 1 PRT5IE 1 PRT5GS 1 PRT5DM2 1 1 1 1 1 1 1 1 DBB00DR0 2 DBB00DR1 2	14 15	RW	DBB30DR2	52	RW	ASD20CR2	92	RW		D2	
PRT5IE 1 PRT5GS 1 PRT5DM2 1 1 1 1 1 1 1 1 1 DBB00DR0 2 DBB00DR1 2	15	RW	DBB30CR0	53	#	ASD20CR3	93	RW	IDX_PP	D3	RW
PRT5GS 1 PRT5DM2 1 1 1 1 1 1 1 1 1 1 1 DBB00DR0 2 DBB00DR1 2		RW	DBB31DR0	54	#	ASC21CR0	94	RW	MVR_PP	D4	RW
PRT5DM2 1 1 1 1 1 1 1 1 1 1 1 1 1 DBB00DR0 2 DBB00DR1 2	16 I	RW	DBB31DR1	55	W	ASC21CR1	95	RW	MVW_PP	D5	RW
1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1		RW	DBB31DR2	56	RW	ASC21CR2	96	RW	I2C_CFG	D6	RW
1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	17	RW	DBB31CR0	57	#	ASC21CR3	97	RW	I2C_SCR	D7	#
1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	18		DCB32DR0	58	#	ASD22CR0	98	RW	I2C_DR	D8	RW
1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	19		DCB32DR1	59	W	ASD22CR1	99	RW	I2C_MSCR	D9	#
1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	1A		DCB32DR2	5A	RW	ASD22CR2	9A	RW	INT_CLR0	DA	RW
1 1 1 DBB00DR0 2 DBB00DR1 2	1B		DCB32CR0	5B	#	ASD22CR3	9B	RW	INT_CLR1	DB	RW
1 DBB00DR0 2 DBB00DR1 2	1C		DCB33DR0	5C	#	ASC23CR0	9C	RW	INT_CLR2	DC	RW
1 DBB00DR0 2 DBB00DR1 2	1D		DCB33DR1	5D	W	ASC23CR1	9D	RW	INT_CLR3	DD	RW
DBB00DR0 2 DBB00DR1 2	1E		DCB33DR2	5E	RW	ASC23CR2	9E	RW	INT_MSK3	DE	RW
DBB00DR1 2			DCB33CR0	5F	#	ASC23CR3	9F	RW	INT_MSK2	DF	RW
		#	AMX_IN	60	RW		A0		INT_MSK0 INT_MSK1	E0	RW
DBB00DR2 2	22	RW		61			A1 A2		_	E1 E2	RW RC
		#	ADE CD	62	DW				RES WDT		
	23 24	#	ARF_CR CMP CR0	63 64	RW #		A3 A4		DEC DH	E3 E4	W RC
	2 <del>4</del> 25	# W	ASY CR		#		A5		DEC_DR	E5	RC
	26	RW	CMP CR1	65 66	# RW		A6		DEC_DE DEC CR0	E6	RW
	27	#	CIVIF_CR1	67	KVV		A7		DEC_CR0	E7	RW
	28	#		68		MUL1 X	A8	W	MUL0 X	E8	W
	29	# W		69		MUL1 Y	A9	W	MUL0 Y	E9	W
	29 2A	RW		6A		MUL1_T	AA	R	MUL0_T	EA	R
	2B	#		6B		_	AB	R	_	EB	R
	2C	#	TMP DR0	6C	RW	MUL1_DL ACC1 DR1	AC	RW	MUL0_DL ACC0 DR1	EC	RW
	2D	# W	TMP_DR0	6D	RW	ACC1_DR1	AD	RW	ACC0_DR1	ED	RW
	2E	RW	TMP_DR1	6E	RW	ACC1_DR0 ACC1 DR3	AE	RW	ACC0_DR0 ACC0_DR3	EE	RW
	2F	#	TMP_DR3	6F	RW	ACC1_DR3	AF	RW	ACC0_DR3	EF	RW
	30	#	ACB00CR3	70	RW	RDI0RI	B0	RW	, .000_DIX2	F0	1744
	31	# W	ACB00CR0	71	RW	RDI0SYN	B1	RW	<u> </u>	F1	<del>                                     </del>
	32	RW	ACB00CR1	72	RW	RDI0IS	B2	RW		F2	
	33	#	ACB00CR1	73	RW	RDI0LT0	B3	RW	<u> </u>	F3	<del>                                     </del>
	34	#	ACB01CR3	74	RW	RDI0LT1	B4	RW	<del>                                     </del>	F4	-
	35	W	ACB01CR0	75	RW	RDI0RO0	B5	RW	<del>                                     </del>	F5	-
	36	RW	ACB01CR1	76	RW	RDI0RO1	B6	RW		F6	<del>                                     </del>
	37	#	ACB01CR2	77	RW		B7		CPU F	F7	RL
	38	#	ACB02CR3	78	RW	RDI1RI	B8	RW	<u> </u>	F8	
	39	# W	ACB02CR0	79	RW	RDI1SYN	B9	RW	<del>                                     </del>	F9	
	3A	RW	ACB02CR0	7A	RW	RDI1IS	BA	RW	<del> </del>	FA	<b>+</b>
	3B	#	ACB02CR1	7B	RW	RDI1LT0	BB	RW	<u> </u>	FB	<del>                                     </del>
	3C	#	ACB02CR2	7C	RW	RDI1LT1	BC	RW	<u> </u>	FC	
	3D	# W	ACB03CR3	7D	RW	RDI1RO0	BD	RW	<u> </u>	FD	<del>                                     </del>
	טט	RW	ACB03CR0 ACB03CR1	7E	RW	RDI1RO1	BE	RW	CPU SCR1	FE	#
DCB13DR2 3	3E	#	ACB03CR1	7E 7F	RW	וטוווטו	BF	1744	CPU_SCR1	FF	#

Blank fields are Reserved and should not be accessed.

# Access is bit specific.

## Register Map Bank 1 Table: Configuration Space

z	3 >	Þ	z	3 Þ	Þ	z	3 Þ	AC	z	3 Þ	Ą
Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access
PRT0DM0	00	RW	DBB20FN	40	RW	ASC10CR0	80	RW	RDI2RI	C0	RW
PRT0DM1	01	RW	DBB20IN	41	RW	ASC10CR1	81	RW	RDI2SYN	C1	RW
PRT0IC0	02	RW	DBB20OU	42	RW	ASC10CR2	82	RW	RDI2IS	C2	RW
PRT0IC1	03	RW		43		ASC10CR3	83	RW	RDI2LT0	C3	RW
PRT1DM0	04	RW	DBB21FN	44	RW	ASD11CR0	84	RW	RDI2LT1	C4	RW
PRT1DM1	05	RW	DBB21IN	45	RW	ASD11CR1	85	RW	RDI2RO0	C5	RW
PRT1IC0 PRT1IC1	06 07	RW	DBB21OU	46 47	RW	ASD11CR2 ASD11CR3	86 87	RW RW	RDI2RO1	C6 C7	RW
PRT2DM0	08	RW	DCB22FN	48	RW	ASC12CR0	88	RW	RDI3RI	C8	RW
PRT2DM1	09	RW	DCB22IN	49	RW	ASC12CR1	89	RW	RDI3SYN	C9	RW
PRT2IC0	0A	RW	DCB22OU	4A	RW	ASC12CR2	8A	RW	RDI3IS	CA	RW
PRT2IC1	0B	RW		4B		ASC12CR3	8B	RW	RDI3LT0	СВ	RW
PRT3DM0	0C	RW	DCB23FN	4C	RW	ASD13CR0	8C	RW	RDI3LT1	CC	RW
PRT3DM1	0D	RW	DCB23IN	4D	RW	ASD13CR1	8D	RW	RDI3RO0	CD	RW
PRT3IC0	0E	RW	DCB23OU	4E	RW	ASD13CR2	8E	RW	RDI3RO1	CE	RW
PRT3IC1	0F	RW		4F		ASD13CR3	8F	RW		CF	
PRT4DM0	10	RW	DBB30FN	50	RW	ASD20CR0	90	RW	GDI_O_IN	D0	RW
PRT4DM1	11	RW	DBB30IN	51	RW	ASD20CR1	91	RW	GDI_E_IN	D1	RW
PRT4IC0	12	RW	DBB30OU	52	RW	ASD20CR2	92	RW	GDI_O_OU	D2	RW
PRT4IC1	13	RW		53		ASD20CR3	93	RW	GDI_E_OU	D3	RW
PRT5DM0	14	RW	DBB31FN	54	RW	ASC21CR0	94	RW		D4	
PRT5DM1	15	RW	DBB31IN	55	RW	ASC21CR1	95	RW		D5	
PRT5IC0	16	RW	DBB31OU	56	RW	ASC21CR2	96	RW		D6	
PRT5IC1	17	RW	DODOGENI	57	DIA	ASC21CR3	97	RW		D7	
	18		DCB32FN	58	RW	ASD22CR0	98	RW		D8	
	19 1A		DCB32IN DCB32OU	59 5A	RW RW	ASD22CR1	99 9A	RW RW		D9 DA	
	1B		DCB3200	5B	RVV	ASD22CR2 ASD22CR3	9A 9B	RW		DB	
	1C		DCB33FN	5C	RW	ASC23CR0	9C	RW		DC	
	1D		DCB33IN	5D	RW	ASC23CR1	9D	RW	OSC GO EN	DD	RW
	1E		DCB33OU	5E	RW	ASC23CR2	9E	RW	OSC CR4	DE	RW
	1F		Bobooo	5F		ASC23CR3	9F	RW	OSC CR3	DF	RW
DBB00FN	20	RW	CLK CR0	60	RW		A0		OSC_CR0	E0	RW
DBB00IN	21	RW	CLK_CR1	61	RW		A1		OSC_CR1	E1	RW
DBB00OU	22	RW	ABF_CR0	62	RW		A2		OSC_CR2	E2	RW
	23		AMD_CR0	63	RW		A3		VLT_CR	E3	RW
DBB01FN	24	RW		64			A4		VLT_CMP	E4	R
DBB01IN	25	RW		65			A5			E5	
DBB01OU	26	RW	AMD_CR1	66	RW		A6			E6	
	27		ALT_CR0	67	RW		A7			E7	
DCB02FN	28	RW	ALT_CR1	68	RW		A8		IMO_TR	E8	W
DCB02IN	29	RW	CLK_CR2	69	RW		A9		ILO_TR	E9	W
DCB02OU	2A	RW		6A			AA		BDG_TR	EA	RW
DCDOSEN	2B	D\A/	TMD DD0	6B	DIM		AB		ECO_TR	EB	W
DCB03FN DCB03IN	2C 2D	RW	TMP_DR0 TMP_DR1	6C 6D	RW RW		AC AD			EC ED	
DCB03IN DCB03OU	2E	RW	TMP_DR1	6E	RW		AE			EE	
2000000	2F	1744	TMP_DR3	6F	RW		AF			EF	
DBB10FN	30	RW	ACB00CR3	70	RW	RDI0RI	B0	RW		F0	
DBB10IN	31	RW	ACB00CR0	71	RW	RDI0SYN	B1	RW		F1	
DBB100U	32	RW	ACB00CR1	72	RW	RDI0IS	B2	RW		F2	
	33		ACB00CR2	73	RW	RDI0LT0	B3	RW		F3	
DBB11FN	34	RW	ACB01CR3	74	RW	RDI0LT1	B4	RW		F4	
DBB11IN	35	RW	ACB01CR0	75	RW	RDI0RO0	B5	RW		F5	
DBB11OU	36	RW	ACB01CR1	76	RW	RDI0RO1	B6	RW		F6	
	37		ACB01CR2	77	RW		B7		CPU_F	F7	RL
DCB12FN	38	RW	ACB02CR3	78	RW	RDI1RI	B8	RW		F8	
DCB12IN	39	RW	ACB02CR0	79	RW	RDI1SYN	B9	RW		F9	
DCB12OU	3A	RW	ACB02CR1	7A	RW	RDI1IS	BA	RW	FLS_PR1	FA	RW
	3B		ACB02CR2	7B	RW	RDI1LT0	BB	RW		FB	
DCB13FN	3C	RW	ACB03CR3	7C	RW	RDI1LT1	BC	RW		FC	
DCB13IN	3D	RW	ACB03CR0	7D	RW	RDI1RO0	BD	RW		FD	
DCB13OU	3E	RW	ACB03CR1	7E	RW	RDI1RO1	BE	RW	CPU_SCR1	FE	#
	3F		ACB03CR2	7F	RW	# Access is hit	BF		CPU_SCR0	FF	#

Blank fields are Reserved and should not be accessed.

# Access is bit specific.

# 3. Electrical Specifications



This chapter presents the DC and AC electrical specifications of the CY8C29x66 automotive PSoC device. For the most up to date electrical specifications, confirm that you have the most recent data sheet by going to the web at <a href="http://www.cypress.com/psoc">http://www.cypress.com/psoc</a>.

Specifications are valid for -40  $^{o}C \leq$  T\_A  $\leq$  125  $^{o}C$  and T  $_{J} \leq$  135  $^{o}C,$  except where noted.

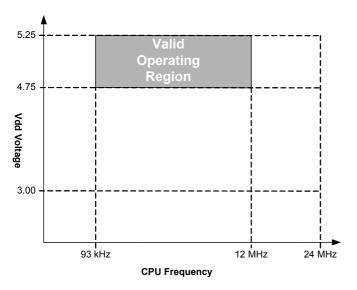


Figure 3-1. Voltage versus CPU Frequency

The following table lists the units of measure that are used in this chapter.

Table 3-1: Units of Measure

Symbol	Unit of Measure	Symbol	Unit of Measure
°C	degree Celsius	μW	microwatts
dB	decibels	mA	milli-ampere
fF	femto farad	ms	milli-second
Hz	hertz	mV	milli-volts
KB	1024 bytes	nA	nanoampere
Kbit	1024 bits	ns	nanosecond
kHz	kilohertz	nV	nanovolts
kΩ	kilohm	Ω	ohm
MHz	megahertz	pA	picoampere
MΩ	megaohm	pF	picofarad
μА	microampere	рр	peak-to-peak
μF	microfarad	ppm	parts per million
μΗ	microhenry	ps	picosecond
μ\$	microsecond	sps	samples per second
μV	microvolts	σ	sigma: one standard deviation
μVrms	microvolts root-mean-square	V	volts

# 3.1 Absolute Maximum Ratings

**Table 3-2: Absolute Maximum Ratings** 

Symbol	Description	Min	Тур	Max	Units	Notes
T <sub>STG</sub>	Storage Temperature	-55	+25	+125	°C	Higher storage temperatures will reduce data retention time. Recommended storage temperature is +25°C ± 25°C. Storage temperatures above 65°C will degrade reliability. Maximum combined storage and operational time at +125°C is 7000 hours.
T <sub>A</sub>	Ambient Temperature with Power Applied	-40	_	+125	°С	
Vdd	Supply Voltage on Vdd Relative to Vss	-0.5	_	+5.75	V	
V <sub>IO</sub>	DC Input Voltage	Vss - 0.5	_	Vdd + 0.5	V	
$V_{IOZ}$	DC Voltage Applied to Tri-state	Vss - 0.5	-	Vdd + 0.5	V	
I <sub>MIO</sub>	Maximum Current into any Port Pin	-25	-	+25	mA	
ESD	Electro Static Discharge Voltage	2000	-	-	V	Human Body Model ESD.
LU	Latch-up Current	-	-	200	mA	

# 3.2 Operating Temperature

**Table 3-3: Operating Temperature** 

Symbol	Description	Min	Тур	Max	Units	Notes
T <sub>A</sub>	Ambient Temperature	-40	-	+125	°C	
TJ	Junction Temperature	-40	-	+135		The temperature rise from ambient to junction is package specific. See "Thermal Impedances" on page 30. The user must limit the power consumption to comply with this requirement.

## 3.3 DC Electrical Characteristics

## 3.3.1 DC Chip-Level Specifications

The following table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and -40°C  $\leq$  T<sub>A</sub>  $\leq$  125°C. Typical parameters apply to 5V at 25°C and are for design guidance only.

Table 3-4: DC Chip-Level Specifications

Symbol	Description	Min	Тур	Max	Units	Notes
Vdd	Supply Voltage	4.75	-	5.25	V	
I <sub>DD</sub>	Supply Current	_	8	15	mA	Conditions are Vdd=5.25V, -40 $^{\circ}$ C $\leq$ T <sub>A</sub> $\leq$ 125 $^{\circ}$ C, CPU=3 MHz, SYSCLK doubler disabled. VC1=1.5 MHz, VC2=93.75 kHz, VC3=0.366 kHz. Analog power = off.
I <sub>SB</sub>	Sleep (Mode) Current with POR, LVD, Sleep Timer, WDT, and internal slow oscillator active. Lower 3/4 temperature range.	_	6	16	μА	Conditions are with internal slow speed oscillator, Vdd = 5.25V, -40 $^{\circ}$ C $\leq$ T <sub>A</sub> $\leq$ 55 $^{\circ}$ C. Analog power = off.
I <sub>SBH</sub>	Sleep (Mode) Current with POR, LVD, Sleep Timer, WDT, and internal slow oscillator active. Higher 1/4 temperature range (hot).	_	6	100	μА	Conditions are with internal slow speed oscillator, Vdd = 5.25V, 55 $^{\rm o}$ C < T <sub>A</sub> $\leq$ 125 $^{\rm o}$ C. Analog power = off.
I <sub>SBXTL</sub>	Sleep (Mode) Current with POR, LVD, Sleep Timer, WDT, internal slow oscillator, and 32 kHz crystal oscillator active. Lower 3/4 temperature range.	_	8	18	μА	Conditions are with properly loaded, 1 $\mu$ W max, 32.768 kHz crystal. Vdd = 5.25V, -40 $^{\circ}$ C $\leq$ T <sub>A</sub> $\leq$ 55 $^{\circ}$ C. Analog power = off.
I <sub>SBXTLH</sub>	Sleep (Mode) Current with POR, LVD, Sleep Timer, WDT, and 32 kHz crystal oscillator active. Higher 1/4 temperature range (hot).	_	8	100	μА	Conditions are with properly loaded, 1 $\mu$ W max, 32.768 kHz crystal. Vdd = 5.25V, 55 $^{\circ}$ C < T <sub>A</sub> $\leq$ 125 $^{\circ}$ C. Analog power = off.
$V_{REF}$	Reference Voltage (Bandgap)	1.25	1.3	1.35	V	

## 3.3.2 DC General Purpose IO Specifications

Table 3-5: DC GPIO Specifications

Symbol	Description	Min	Тур	Max	Units	Notes
R <sub>PU</sub>	Pull-up Resistor	4	5.6	8	kΩ	
R <sub>PD</sub>	Pull-down Resistor	4	5.6	8	kΩ	
V <sub>OH</sub>	High Output Level	3.5	-	-	V	IOH = 10 mA, Vdd = 4.75 to 5.25V (8 total loads, 4 on even port pins (for example, P0[2], P1[4]), 4 on odd port pins (for example, P0[3], P1[5])).
V <sub>OL</sub>	Low Output Level	-	-	0.75	V	IOL = 25 mA, Vdd = 4.75 to 5.25V (8 total loads, 4 on even port pins (for example, P0[2], P1[4]), 4 on odd port pins (for example, P0[3], P1[5])).
V <sub>IL</sub>	Input Low Level	-	_	0.8	V	Vdd = 4.75 to 5.25.
$V_{IH}$	Input High Level	2.2	_		V	Vdd = 4.75 to 5.25.
$V_{H}$	Input Hysterisis	-	110	-	mV	
I <sub>IL</sub>	Input Leakage (Absolute Value)	-	1	-	nA	Gross tested to 1 μA.
C <sub>IN</sub>	Capacitive Load on Pins as Input	-	3.5	10	pF	Package and pin dependent. Temp = 25°C.
C <sub>OUT</sub>	Capacitive Load on Pins as Output	-	3.5	10	pF	Package and pin dependent. Temp = 25°C.

## 3.3.3 DC Operational Amplifier Specifications

The following tables list guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and  $-40^{\circ}\text{C} \le T_A \le 125^{\circ}\text{C}$ . Typical parameters apply to 5V at 25°C and are for design guidance only.

The Operational Amplifier is a component of both the Analog Continuous Time PSoC blocks and the Analog Switched Capacitor PSoC blocks. The guaranteed specifications are measured in the Analog Continuous Time PSoC block.

Table 3-6: DC Operational Amplifier Specifications

Symbol	Description	Min	Тур	Max	Units	Notes
V <sub>OSOA</sub>	Input Offset Voltage (absolute value) Low Power	-	1.6	19	mV	Opamp Bias = High.
	Input Offset Voltage (absolute value) Mid Power		1.3	11	mV	
	Input Offset Voltage (absolute value) High Power	_	1.2	11	mV	
TCV <sub>OSOA</sub>	Input Offset Voltage Drift	-	7.0	35.0	μV/°C	
I <sub>EBOA</sub>	Input Leakage Current (Port 0 Analog Pins)	_	200	-	pA	Gross tested to 1 μA.
C <sub>INOA</sub>	Input Capacitance (Port 0 Analog Pins)	-	4.5	10	pF	Package and pin dependent. Temp = 25°C.
$V_{CMOA}$	Common Mode Voltage Range. All Cases, except highest.	0.0	-	Vdd	V	
	Power = High, Opamp Bias = High	0.5	_	Vdd - 0.5	V	
G <sub>OLOA</sub>	Open Loop Gain	_	80	-	dB	
V <sub>OHIGHOA</sub>	High Output Voltage Swing (worst case internal load)	Vdd - 0.2	-	-	V	
V <sub>OLOWOA</sub>	Low Output Voltage Swing (worst case internal load)	-	-	0.2	V	
I <sub>SOA</sub>	Supply Current (including associated AGND buffer)					
	Power=Low	-	150	200	μА	
	Power=Low, Opamp Bias=High	-	300	800	μА	
	Power=Medium	_	600	800	μА	
	Power=Medium, Opamp Bias=High	_	1210	1700	μА	
	Power=High	_	2400	3200	μА	
	Power=High, Opamp Bias=High	_	4600	6800	μА	
PSRR <sub>OA</sub>	Supply Voltage Rejection Ratio	-	80	-	dB	$ \begin{tabular}{ll} Vss \le VIN \le (Vdd - 2.25) \ or \ (Vdd - 1.25V) \le \\ VIN \le Vdd. \end{tabular} $

## 3.3.4 DC Low Power Comparator Specifications

The following tables list guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and  $-40^{\circ}\text{C} \le T_{A} \le 125^{\circ}\text{C}$ . Typical parameters apply to 5V at 25°C and are for design guidance only.

Table 3-7. DC Low Power Comparator Specifications

Symbol	Description	Min	Тур	Max	Units	Notes
$V_{REFLPC}$	Low power comparator (LPC) reference voltage range	0.2	-	Vdd - 1	V	
I <sub>SLPC</sub>	LPC supply current	_	10	40	μΑ	
V <sub>OSLPC</sub>	LPC voltage offset	-	2.5	30	mV	

## 3.3.5 DC Analog Output Buffer Specifications

Table 3-8: DC Analog Output Buffer Specifications

Symbol	Description	Min	Тур	Max	Units	Notes
V <sub>OSOB</sub>	Input Offset Voltage (Absolute Value)	-	3	19	mV	
TCV <sub>OSOB</sub>	Input Offset Voltage Drift	_	+6	_	μV/°C	
V <sub>CMOB</sub>	Common-Mode Input Voltage Range	0.5	_	Vdd - 1.0	V	
R <sub>OUTOB</sub>	Output Resistance	-	1	-	Ω	
V <sub>OHIGHOB</sub>	High Output Voltage Swing (Load = 32 ohms to Vdd/2)	0.5 x Vdd + 1.3	_	_	٧	
V <sub>OLOWOB</sub>	Low Output Voltage Swing (Load = 32 ohms to Vdd/2)	-	_	0.5 x Vdd - 1.3	V	
I <sub>SOB</sub>	Supply Current Including Bias Cell (No Load)					
	Power = Low	-	1.1	5.1	mA	
	Power = High	_	2.6	8.8	mA	
PSRR <sub>OB</sub>	Supply Voltage Rejection Ratio	-	64	_	dB	

## 3.3.6 DC Analog Reference Specifications

The following tables list guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and  $-40^{\circ}\text{C} \le T_A \le 125^{\circ}\text{C}$ . Typical parameters apply to 5V at 25°C and are for design guidance only.

The guaranteed specifications are measured through the Analog Continuous Time PSoC blocks. The power levels for AGND refer to the power of the Analog Continuous Time PSoC block. The power levels for RefHi and RefLo refer to the Analog Reference Control register. The limits stated for AGND include the offset error of the AGND buffer local to the Analog Continuous Time PSoC block.

Table 3-9: DC Analog Reference Specifications

Symbol	Description	Min	Тур	Max	Units
$V_{BG5}$	Bandgap Voltage Reference 5V	1.25	1.30	1.35	V
_	AGND = Vdd/2 <sup>a</sup>				
	CT Block Power = High	Vdd/2 - 0.02	Vdd/2	Vdd/2 + 0.02	V
_	AGND = 2 x BandGap <sup>a</sup>				
	CT Block Power = High	2.4	2.60	2.8	V
_	AGND = P2[4] (P2[4] = Vdd/2) <sup>a</sup>				
	CT Block Power = High	P2[4] - 0.02	P2[4]	P2[4] + 0.02	V
_	AGND = BandGap <sup>a</sup>				
	CT Block Power = High	1.23	1.3	1.37	V
_	AGND = 1.6 x BandGap <sup>a</sup>				
	CT Block Power = High	1.98	2.08	2.14	V
_	AGND Column to Column Variation (AGND=Vdd/2) <sup>a</sup>				
	CT Block Power = High	- 0.035	0.000	0.035	V
_	RefHi = Vdd/2 + BandGap				
	Ref Control Power = High	Vdd/2 + 1.15	Vdd/2 + 1.30	Vdd/2 + 1.45	V
_	RefHi = 3 x BandGap				
	Ref Control Power = High	3.65	3.9	4.15	V
_	RefHi = 2 x BandGap + P2[6] (P2[6] = 1.3V)				
	Ref Control Power = High	P2[6] + 2.4	P2[6] + 2.6	P2[6] + 2.8	V
_	RefHi = P2[4] + BandGap (P2[4] = Vdd/2)				
	Ref Control Power = High	P2[4] + 1.24	P2[4] + 1.30	P2[4] + 1.36	V
_	RefHi = P2[4] + P2[6] (P2[4] = Vdd/2, P2[6] = 1.3V)				
	Ref Control Power = High	P2[4] + P2[6] - 0.1	P2[4] + P2[6]	P2[4] + P2[6] + 0.1	V
_	RefHi = 2 x BandGap				
	Ref Control Power = High	2.4	2.60	2.8	V
_	RefHi = 3.2 x BandGap				
	Ref Control Power = High	3.9	4.16	4.42	V
_	RefLo = Vdd/2 – BandGap				.,
	Ref Control Power = High	Vdd/2 - 1.45	Vdd/2 - 1.3	Vdd/2 - 1.15	V
_	RefLo = BandGap		4.00		.,
	Ref Control Power = High	1.15	1.30	1.45	V
_	RefLo = 2 x BandGap - P2[6] (P2[6] = 1.3V)	2.4 Doro	a e porci	2 0 1 DOIG	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \
	Ref Control Power = High  RefLo = P2[4] – BandGap (P2[4] = Vdd/2)	2.4 - P2[6]	2.6 - P2[6]	2.8 + P2[6]	V
_	Ref Control Power = High	D2[4] 1.45	D2[4] 1 2	D2[4] 1 15	V
_	RefLo = P2[4]-P2[6] (P2[4] = Vdd/2, P2[6] = 1.3V)	P2[4] - 1.45	P2[4] - 1.3	P2[4] - 1.15	V
_	Ref Control Power = High	P2[4] - P2[6] - 0.1	P2[4] - P26	P2[4] - P2[6] + 0.1	V
	Troi Control Fower - Flight	1 2[7] 1 2[0] - 0.1	1 2[7] 1 20	1 2[7] 1 2[0] 1 0.1	٧

a. AGND tolerance includes the offsets of the local buffer in the PSoC block. BG = Bandgap voltage is  $1.3V \pm 0.05V$ .

## 3.3.7 DC Analog PSoC Block Specifications

The following table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and  $-40^{\circ}\text{C} \le T_A \le 125^{\circ}\text{C}$ . Typical parameters apply to 5V at 25°C and are for design guidance only.

Table 3-10: DC Analog PSoC Block Specifications

ĺ	Symbol	Description	Min	Тур	Max	Units	Notes
ſ	R <sub>CT</sub>	Resistor Unit Value (Continuous Time)	-	12.24	-	kΩ	
	C <sub>SC</sub>	Capacitor Unit Value (Switch Cap)	-	80	-	fF	

## 3.3.8 DC POR, and LVD Specifications

Table 3-11: DC POR, and LVD Specifications

Symbol	Description	Min	Тур	Max	Units	Notes
	Vdd Value for PPOR Trip (positive ramp)					
V <sub>PPOR1R</sub>	PORLEV[1:0] = 01b	_	4.40	_	V	
$V_{PPOR2R}$	PORLEV[1:0] = 10b		4.60		V	
	Vdd Value for PPOR Trip (negative ramp)					
V <sub>PPOR1</sub>	PORLEV[1:0] = 01b	_	4.40	_	V	
V <sub>PPOR2</sub>	PORLEV[1:0] = 10b		4.60		V	
	PPOR Hysteresis					
V <sub>PH1</sub>	PORLEV[1:0] = 01b	_	0	_	mV	
$V_{PH2}$	PORLEV[1:0] = 10b	_	0	_	mV	
	Vdd Value for LVD Trip					
$V_{LVD6}$	VM[2:0] = 110b	4.65	4.80	4.90	V	
$V_{LVD7}$	VM[2:0] = 111b	4.75	4.90	5.00	V	

## 3.3.9 DC Programming Specifications

**Table 3-12: DC Programming Specifications** 

Symbol	Description	Min	Тур	Max	Units	Notes
I <sub>DDP</sub>	Supply Current During Programming or Verify	-	15	30	mA	
V <sub>ILP</sub>	Input Low Voltage During Programming or Verify	-	-	0.8	V	
V <sub>IHP</sub>	Input High Voltage During Programming or Verify	2.2	_	_	V	
I <sub>ILP</sub>	Input Current when Applying Vilp to P1[0] or P1[1] During Programming or Verify	_	-	0.2	mA	Driving internal pull-down resistor.
I <sub>IHP</sub>	Input Current when Applying Vihp to P1[0] or P1[1] During Programming or Verify	-	_	1.5	mA	Driving internal pull-down resistor.
V <sub>OLV</sub>	Output Low Voltage During Programming or Verify	-	-	Vss + 0.75	V	
V <sub>OHV</sub>	Output High Voltage During Programming or Verify	3.5	_	Vdd	V	
Flash <sub>ENPB</sub>	Flash Endurance (per block) <sup>a</sup>	100	-	_	_	Erase/write cycles per block.
Flash <sub>ENT</sub>	Flash Endurance (total) <sup>a,b</sup>	51,200	-	-	_	Erase/write cycles.
Flash <sub>DR</sub>	Flash Data Retention <sup>c</sup>	15	-	-	Years	

a. For the full temperature range, the user must employ a temperature sensor user module (FlashTemp) and feed the result to the temperature argument before writing. Refer to the Flash APIs Application Note AN2015 at http://www.cypress.com under Application Notes for more information.

b. A maximum of 512 x 100 block endurance cycles is allowed.

c. Flash data retention based on the use condition of  $\leq$  7000 hours at  $T_A \leq$  125°C and the remaining time at  $T_A \leq$  65°C.

## 3.4 AC Electrical Characteristics

## 3.4.1 AC Chip-Level Specifications

Table 3-13: AC Chip-Level Specifications

Symbol	Description	Min	Тур	Max	Units	Notes
F <sub>IMO24</sub>	Internal Main Oscillator Frequency for 24 MHz	22.95	24	24.96	MHz	Trimmed. Utilizing factory trim values.
F <sub>CPU1</sub>	CPU Frequency (5V Nominal)	0.09	12	12.48	MHz	
F <sub>48M</sub>	Digital PSoC Block Frequency	-	<b>–</b>	_	MHz	Not allowed.
F <sub>24M</sub>	Digital PSoC Block Frequency	0	24	24.96 <sup>a</sup>	MHz	
F <sub>32K1</sub>	Internal Low Speed Oscillator Frequency	15	32	64	kHz	
F <sub>32K2</sub>	External Crystal Oscillator	-	32.768	_	kHz	Accuracy is capacitor and crystal dependent.
F <sub>PLL</sub>	PLL Frequency	-	23.986	-	MHz	Is a multiple (x732) of crystal frequency.
Jitter24M2	24 MHz Period Jitter (PLL)	_	-	800	ps	
T <sub>PLLSLEW</sub>	PLL Lock Time	0.5	-	10	ms	
T <sub>PLLSLEWS</sub> - LOW	PLL Lock Time for Low Gain Setting	0.5	-	50	ms	
T <sub>OS</sub>	External Crystal Oscillator Startup to 1%	-	1700	2620	ms	
T <sub>OSACC</sub>	External Crystal Oscillator Startup to 200 ppm	-	2800	3800	ms	
Jitter32k	32 kHz Period Jitter	_	100		ns	
T <sub>XRST</sub>	External Reset Pulse Width	10	-	_	μS	
DC24M	24 MHz Duty Cycle	40	50	60	%	
Step24M	24 MHz Trim Step Size	-	50	-	kHz	
Jitter24M1P	24 MHz Period Jitter (IMO) Peak-to-Peak	-	300		ps	
Jitter24M1R	24 MHz Period Jitter (IMO) Root Mean Squared	-	-	600	ps	
F <sub>MAX</sub>	Maximum frequency of signal on row input or row output.	_	-	12.48	MHz	
T <sub>RAMP</sub>	Supply Ramp Time	0	-	_	μS	

a. See the individual user module data sheets for information on maximum frequencies for user modules.

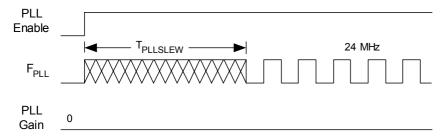


Figure 3-2. PLL Lock Timing Diagram

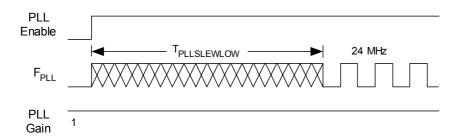


Figure 3-3. PLL Lock for Low Gain Setting Timing Diagram

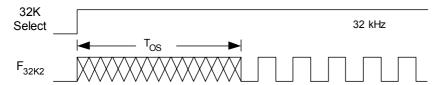


Figure 3-4. External Crystal Oscillator Startup Timing Diagram



Figure 3-5. 24 MHz Period Jitter (IMO) Timing Diagram



Figure 3-6. 32 kHz Period Jitter (ECO) Timing Diagram

## 3.4.2 AC General Purpose IO Specifications

Table 3-14: AC GPIO Specifications

Symbol	Description	Min	Тур	Max	Units	Notes
F <sub>GPIO</sub>	GPIO Operating Frequency	0	_	12.48	MHz	Normal Strong Mode
TRiseF	Rise Time, Normal Strong Mode, Cload = 50 pF	3	-	22	ns	Vdd = 4.75 to 5.25V, 10% - 90%
TFallF	Fall Time, Normal Strong Mode, Cload = 50 pF	2	-	22	ns	Vdd = 4.75 to 5.25V, 10% - 90%
TRiseS	Rise Time, Slow Strong Mode, Cload = 50 pF	9	27	-	ns	Vdd = 4.75 to 5.25V, 10% - 90%
TFallS	Fall Time, Slow Strong Mode, Cload = 50 pF	9	22	_	ns	Vdd = 4.75 to 5.25V, 10% - 90%

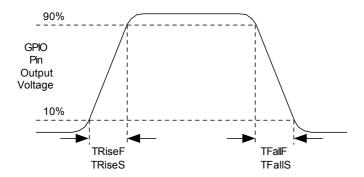


Figure 3-7. GPIO Timing Diagram

## 3.4.3 AC Operational Amplifier Specifications

The following tables list guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and -40°C  $\leq$  T<sub>A</sub>  $\leq$  125°C. Typical parameters apply to 5V at 25°C and are for design guidance only.

Settling times, slew rates, and gain bandwidth are based on the Analog Continuous Time PSoC block.

Table 3-15: AC Operational Amplifier Specifications

Symbol	Description	Min	Тур	Max	Units	Notes
SR <sub>ROA</sub>	Rising Slew Rate (20% to 80%) of a 1V Step (10 pF load, Unity Gain)					
	Power = Low	0.15	-		V/μs	
	Power = Low, Opamp Bias = High	0.15			V/μs	
	Power = Medium	0.15			V/μs	
	Power = Medium, Opamp Bias = High	1.7	-		V/μs	
	Power = High	1.7			V/μs	
	Power = High, Opamp Bias = High	6.5	-		V/μs	
SR <sub>FOA</sub>	Falling Slew Rate (20% to 80%) of a 1V Step (10 pF load, Unity Gain)					
	Power = Low	0.01	-		V/μs	
	Power = Low, Opamp Bias = High	0.01			V/μs	
	Power = Medium	0.01			V/μs	
	Power = Medium, Opamp Bias = High	0.5	_		V/μs	
	Power = High	0.5			V/μs	
	Power = High, Opamp Bias = High	4.0	_		V/μs	
BW <sub>OA</sub>	Gain Bandwidth Product					
	Power = Low	0.75	_		MHz	
	Power = Low, Opamp Bias = High	0.75			MHz	
	Power = Medium	0.75			MHz	
	Power = Medium, Opamp Bias = High	3.1	_		MHz	
	Power = High	3.1			MHz	
	Power = High, Opamp Bias = High	5.4	_		MHz	

When bypassed by a capacitor on P2[4], the noise of the analog ground signal distributed to each block is reduced by a factor of up to 5 (14 dB). This is at frequencies above the corner frequency defined by the on-chip 8.1k resistance and the external capacitor.

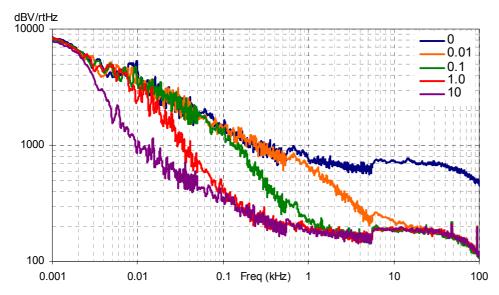


Figure 3-8. Typical AGND Noise with P2[4] Bypass

At low frequencies, the opamp noise is proportional to 1/f, power independent, and determined by device geometry. At high frequencies, increased power level reduces the noise spectrum level.

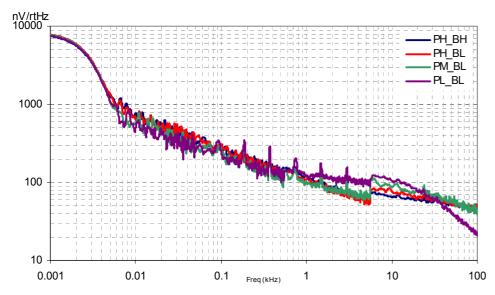


Figure 3-9. Typical Opamp Noise

## 3.4.4 AC Low Power Comparator Specifications

The following tables list guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and -40°C  $\leq$  T<sub>A</sub>  $\leq$  125°C. Typical parameters apply to 5V at 25°C and are for design guidance only.

**Table 3-16. AC Low Power Comparator Specifications** 

Symbol	Description	Min	Тур	Max	Units	Notes
T <sub>RLPC</sub>	LPC response time	_	_	50		≥ 50 mV overdrive comparator reference set
						within V <sub>REFLPC</sub> .

## 3.4.5 AC Digital Block Specifications

Table 3-17: AC Digital Block Specifications

Function	Description	Min	Тур	Max	Units	Notes
All Functions	Maximum Block Clocking Frequency (> 4.75V)			24.96	MHz	4.75V < Vdd < 5.25V.
Timer	Capture Pulse Width	50 <sup>a</sup>	-	-	ns	
	Maximum Frequency, No Capture	-	_	24.96	MHz	4.75V < Vdd < 5.25V.
	Maximum Frequency, With Capture	-	-	24.96	MHz	
Counter	Enable Pulse Width	50 <sup>a</sup>	_	_	ns	
	Maximum Frequency, No Enable Input	-	_	24.96	MHz	4.75V < Vdd < 5.25V.
	Maximum Frequency, Enable Input	_	_	24.96	MHz	
Dead Band	Kill Pulse Width:					
	Asynchronous Restart Mode	20	-	-	ns	
	Synchronous Restart Mode	50 <sup>a</sup>	_	_	ns	
	Disable Mode	50 <sup>a</sup>	-	_	ns	
	Maximum Frequency	-	-	24.96	MHz	4.75V < Vdd < 5.25V.
CRCPRS (PRS Mode)	Maximum Input Clock Frequency	-	-	24.96	MHz	4.75V < Vdd < 5.25V.
CRCPRS (CRC Mode)	Maximum Input Clock Frequency	-	-	24.96	MHz	
SPIM	Maximum Input Clock Frequency	-	-	4	MHz	Maximum data rate at 4.1 MHz due to 2 x over clocking.
SPIS	Maximum Input Clock Frequency	-	_	2	MHz	
	Width of SS_ Negated Between Transmissions	50 <sup>a</sup>	-	-	ns	
Transmitter	Maximum Input Clock Frequency	-,	-	8	MHz	Maximum data rate at 3.08 MHz due to 8 x over clocking.
Receiver	Maximum Input Clock Frequency	-	16	24.96	MHz	Maximum data rate at 3.08 MHz due to 8 x over clocking.

a. 50 ns minimum input pulse width is based on the input synchronizers running at 24 MHz (42 ns nominal period).

#### 3.4.6 AC Analog Output Buffer Specifications

The following tables list guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and  $-40^{\circ}\text{C} \le T_A \le 125^{\circ}\text{C}$ . Typical parameters apply to 5V at 25°C and are for design guidance only.

Table 3-18: AC Analog Output Buffer Specifications

Symbol	Description	Min	Тур	Max	Units	Notes
T <sub>ROB</sub>	Rising Settling Time to 0.1%, 1V Step, 100pF Load					
	Power = Low	_	-	4	μS	
	Power = High	_	-	4	μS	
T <sub>SOB</sub>	Falling Settling Time to 0.1%, 1V Step, 100pF Load					
	Power = Low	-	-	4	μS	
	Power = High	_	-	4	μS	
SR <sub>ROB</sub>	Rising Slew Rate (20% to 80%), 1V Step, 100pF Load					
	Power = Low	0.6	-	-	V/μs	
	Power = High	0.6	_	_	V/μs	
SR <sub>FOB</sub>	Falling Slew Rate (80% to 20%), 1V Step, 100pF Load					
	Power = Low	0.6	-	-	V/μs	
	Power = High	0.6	_	_	V/μs	
BW <sub>OB</sub>	Small Signal Bandwidth, 20mV <sub>pp</sub> , 3dB BW, 100pF Load					
	Power = Low	0.8	-	-	MHz	
	Power = High	8.0	-	-	MHz	
BW <sub>OB</sub>	Large Signal Bandwidth, 1V <sub>pp</sub> , 3dB BW, 100pF Load					
	Power = Low	300	-	_	kHz	
	Power = High	300	_	_	kHz	

## 3.4.7 AC External Clock Specifications

The following tables list guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and -40°C  $\leq$  T<sub>A</sub>  $\leq$  125°C. Typical parameters apply to 5V at 25°C and are for design guidance only.

Table 3-19: AC External Clock Specifications

Symbol	Description		Тур	Max	Units	Notes
F <sub>OSCEXT</sub>	Frequency	0	_	24.24	MHz	
_	High Period	20.6	_	_	ns	
_	Low Period	20.6	-	-	ns	
_	Power Up IMO to Switch	150	-	-	μS	

#### 3.4.8 AC Programming Specifications

**Table 3-20: AC Programming Specifications** 

Symbol	Description	Min	Тур	Max	Units	Notes
T <sub>RSCLK</sub>	Rise Time of SCLK	1	_	20	ns	
T <sub>FSCLK</sub>	Fall Time of SCLK	1	_	20	ns	
T <sub>SSCLK</sub>	Data Set up Time to Falling Edge of SCLK 40 – ns					
T <sub>HSCLK</sub>	Data Hold Time from Falling Edge of SCLK	40	_	_	ns	
F <sub>SCLK</sub>	Frequency of SCLK	0	_	8	MHz	
T <sub>ERASEB</sub>	Flash Erase Time (Block)	_	15	_	ms	
T <sub>WRITE</sub>	Flash Block Write Time	-	30	_	ms	
T <sub>DSCLK</sub>	Data Out Delay from Falling Edge of SCLK	-	_	45	ns	

# 3.4.9 AC I<sup>2</sup>C Specifications

Table 3-21: AC Characteristics of the I<sup>2</sup>C SDA and SCL Pins

		Standa	rd Mode	Fast Mode			
Symbol	Description	Min	Max	Min Max		Units	Notes
F <sub>SCLI2C</sub>	SCL Clock Frequency	0	100	0	400	kHz	
T <sub>HDSTAI2C</sub>	Hold Time (repeated) START Condition. After this period, the first clock pulse is generated.	4.0	_	0.6	_	μ\$	
T <sub>LOWI2C</sub>	LOW Period of the SCL Clock	4.7	-	1.3	-	μS	
T <sub>HIGHI2C</sub>	HIGH Period of the SCL Clock	4.0	_	0.6	-	μS	
T <sub>SUSTAI2C</sub>	Set-up Time for a Repeated START Condition	4.7	_	0.6	-	μS	
T <sub>HDDATI2C</sub>	Data Hold Time	0	_	0	-	μS	
T <sub>SUDATI2C</sub>	Data Set-up Time	250	_	100 <sup>a</sup>	-	ns	
T <sub>SUSTOI2C</sub>	Set-up Time for STOP Condition	4.0	_	0.6		μS	
T <sub>BUFI2C</sub>	Bus Free Time Between a STOP and START Condition	4.7	_	1.3	-	μS	
T <sub>SPI2C</sub>	Pulse Width of spikes are suppressed by the input filter.	_	_	0	50	ns	

a. A Fast-Mode I2C-bus device can be used in a Standard-Mode I2C-bus system, but the requirement t<sub>SU;DAT</sub> ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line t<sub>rmax</sub> + t<sub>SU;DAT</sub> = 1000 + 250 = 1250 ns (according to the Standard-Mode I2C-bus specification) before the SCL line is released.

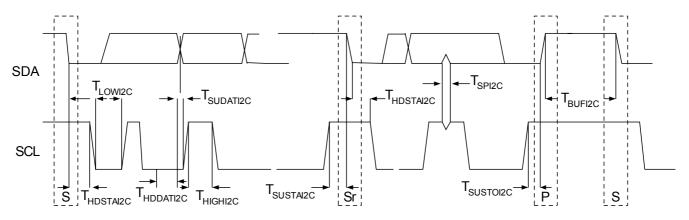


Figure 3-10. Definition for Timing for Fast/Standard Mode on the I<sup>2</sup>C Bus

# 4. Packaging Information



This chapter illustrates the packaging specifications for the CY8C29x66 automotive PSoC device, along with the thermal impedances and solder reflow for each package and the typical package capacitance on crystal pins.

**Important Note** Emulation tools may require a larger area on the target PCB than the chip's footprint. For a detailed description of the emulation tools' dimensions, refer to the document titled *PSoC Emulator Pod Dimensions* at <a href="http://www.cypress.com/design/MR10161">http://www.cypress.com/design/MR10161</a>.

## 4.1 Packaging Dimensions

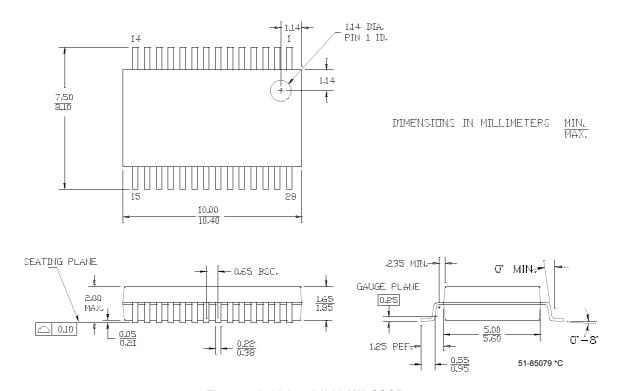


Figure 4-1. 28-Lead (210-Mil) SSOP

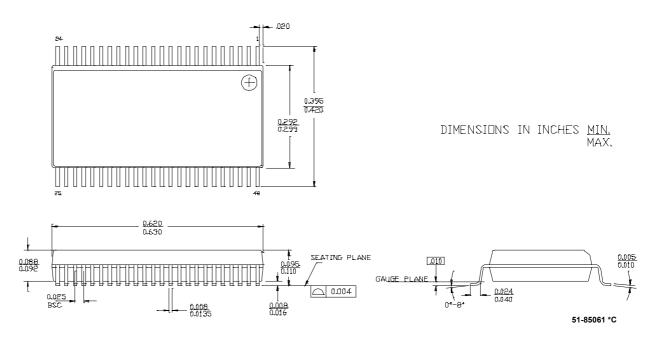


Figure 4-2. 48-Lead (300-Mil) SSOP

# 4.2 Thermal Impedances

Table 4-1: Thermal Impedances per Package

Package	Typical $\theta_{JA}^{\star}$
28 SSOP	95°C/W
48 SSOP	69 °C/W

<sup>\*</sup>  $T_J$  =  $T_A$  + POWER x  $\theta_{JA}$ 

# 4.3 Capacitance on Crystal Pins

Table 4-2: Typical Package Capacitance on Crystal Pins

Package	Package Capacitance
28 SSOP	2.8 pF
48 SSOP	3.3 pF

## 4.4 Solder Reflow Peak Temperature

Following is the minimum solder reflow peak temperature to achieve good solderability.

Table 4-3. Solder Reflow Peak Temperature

Package	Minimum Peak Temperature*	Maximum Peak Temperature
28 SSOP	240°C	260°C
48 SSOP	220°C	260°C

<sup>\*</sup>Higher temperatures may be required based on the solder melting point. Typical temperatures for solder are 220  $\pm$  5°C with Sn-Pb or 245  $\pm$  5°C with Sn-Ag-Cu paste. Refer to the solder manufacturer specifications.

# 5. Ordering Information

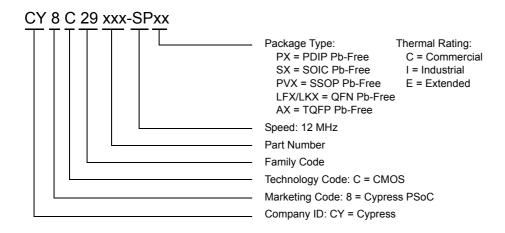


The following table lists the CY8C29x66 PSoC device's key package features and ordering codes.

Table 5-1: CY8C29x66 Automotive PSoC Key Features and Ordering Information

Package	Ordering Code	Flash (Bytes)	RAM (Bytes)	Temperature Range	Digital PSoC Blocks	Analog PSoC Blocks	Digital IO Pins	Analog Inputs	Analog Outputs	XRES Pin
28 Pin (210 Mil) SSOP	CY8C29466-12PVXE	32K	2K	-40C to +125C	16	12	24	12	4	Yes
28 Pin (210 Mil) SSOP (Tape and Reel)	CY8C29466-12PVXET	32K	2K	-40C to +125C	16	12	24	12	4	Yes
48 Pin (300 Mil) SSOP	CY8C29666-12PVXE	32K	2K	-40C to +125C	16	12	44	12	4	Yes
48 Pin (300 Mil) SSOP (Tape and Reel)	CY8C29666-12PVXET	32K	2K	-40C to +125C	16	12	44	12	4	Yes

## 5.1 Ordering Code Definitions



# 6. Sales and Service Information



To obtain information about Cypress Semiconductor or PSoC sales and technical support, reference the following information.

#### **Cypress Semiconductor**

198 Champion Court San Jose, CA 95134 408.943.2600

Web Sites: Company Information - http://www.cypress.com

Sales - http://www.cypress.com/aboutus/sales\_locations.cfm

Technical Support - http://www.cypress.com/support/login.cfm

## 6.1 Revision History

#### Table 6-1: CY8C29x66 Automotive Data Sheet Revision History

Document Title: CY8C29466 and CY8C29666 Automotive PSoC® Mixed-Signal Array Final Data Sheet  Document Number: 38-12026						
Revision	ECN#	Issue Date	Origin of Change	Description of Change		
**	228771	06/01/2004	SFV	First release of the CY8C29x66 automotive PSoC device data sheet.		
*A	271452	See ECN	HMT	Update per SFV memo. Input changes from MWR, including removing SMP.		
*B	288029	See ECN	HMT	Add Reflow Peak Temp. table. Update PSoC Characteristics table. Update characterization data.		
*C	473829	See ECN	НМТ	Update PSoC Characteristics table. Update characterization data. Update Storage Temperature for extended temperature devices. Fix error in Register Bank 0/1. Update CY color, logo and copyright.		
*D	602219	See ECN	НМТ	Add Low Power Comparator (LPC) AC/DC electrical spec. tables. Add CY8C20x34 to PSoC Device Characteristics table. Update Technical Training Modules paragraph. Add ISSP note to pinout tables.		
Distribution	External/Publ	ic	Posting: None			

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